

3V 900 MHz LINEAR POWER AMPLIFIER

RoHS Compliant & Pb-Free Product Package Style: QFN, 16-Pin, 4 x 4

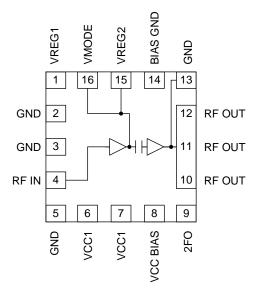


Features

- Single 3V Supply
- 29dBm Linear Output Power
- 37% Linear Efficiency
- Low Power Mode
- 45 mA idle current
- 47% Peak Efficiency 31dBm Output

Applications

- 3V CDMA/AMPS Cellular Handsets
- 3V JCDMA Cellular Handsets
- 3V CDMA2000 Cellular Handsets
- 3V TDMA/GAIT Cellular Handsets
- 3V CDMA 450MHz Band Handsets
- Portable Battery-Powered Equipment



Functional Block Diagram

Product Description

The RF2192 is a high-power, high-efficiency linear amplifier IC targeting 3V handheld systems. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as the final RF amplifier in dual-mode 3V CDMA/AMPS and CDMA2000 handheld digital cellular equipment, spread-spectrum systems, and other applications in the 800MHz to 960MHz band. The RF2192 has a low power mode to extend battery life under low output power conditions. The device is packaged in a 16-pin, 4mmx4mm QFN.

Ordering Information

RF2192 3V 900MHz Linear Power Amplifier RF2192PCBA-41X Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

| ☑ GaAs HBT ☐ GaAs MESFET | ☐ SiGe BiCMOS ☐ Si BiCMOS | ☐ GaAs pHEMT☐ Si CMOS | ☐ GaN HEMT☐ RF MEMS |
|--------------------------|------------------------------|-----------------------|---------------------|
| ☐ InGaP HBT | ☐ SiGe HBT | ☐ Si BJT | |

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RF2192



Absolute Maximum Ratings

| Parameter | Rating | Unit |
|--|-------------|-----------------|
| Supply Voltage (RF off) | +8.0 | V _{DC} |
| Supply Voltage (P _{OUT} ≤31dBm) | +5.2 | V_{DC} |
| Mode Voltage (V _{MODE}) | +4.2 | V_{DC} |
| Control Voltage (V _{REG}) | +3.0 | V_{DC} |
| Input RF Power | +10 | dBm |
| Operating Case Temperature | -30 to +110 | °C |
| Storage Temperature | -40 to +150 | °C |



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

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| Parameter | Specification | | | I line: 4 | Oh an diti an | |
|--|---------------|------|------|-----------|---|--|
| | Min. | Тур. | Max. | Unit | Chondition | |
| Usable Frequency Range | 400 | _ | 960 | MHz | | |
| High Power State- US-CDMA (V _{MODE} Low) | | | | | Case T=25°C, V _{CC} =3.4V, V _{REG} = 2.85V, V _{MODE} =0V to 0.5V, Freq=824 MHz to 849 MHz (unless otherwise specified) | |
| Frequency Range | 824 | | 849 | MHz | | |
| Linear Gain | 27 | 30 | | dB | | |
| Second Harmonic | | -33 | | dBc | | |
| Third Harmonic | | <-60 | | dBc | | |
| Maximum Linear Output Power (CDMA Modulation) | 29 | | | dBm | | |
| Total Linear Efficiency | | 37 | | % | P _{OUT} =29dBm | |
| Adjacent Channel Power Rejection | | -48 | -44 | dBc | ACPR@885kHz | |
| | | -58 | -56 | dBc | ACPR@1980kHz | |
| Input VSWR | | 2:1 | | | | |
| Output VSWR | | | 10:1 | | No damage. | |
| | | | 6:1 | | No oscillations. >-70dBc | |
| Noise Power | | -133 | | dBm/Hz | At 45 MHz offset | |
| Low Power State- US-CDMA (V _{MODE} High) | | | | | Case T=25 °C, V _{CC} =3.4V, V _{REG} =2.85V, V _{MODE} =1.8V to 3V, Freq=824MHz to 849MHz (unless otherwise specified) | |
| Frequency Range | 824 | | 849 | MHz | | |
| Linear Gain | 19 | 22 | | dB | | |
| Second Harmonic | | -33 | | dBc | | |
| Third Harmonic | | <-60 | | dBc | | |
| Maximum Linear Output Power (CDMA Modulation) | 16 | 20 | | dBm | | |
| Max I _{CC} | | 150 | | mA | P _{OUT} =+16dBm (all currents included) | |
| Adjacent Channel Power Rejection | | -48 | -46 | dBc | ACPR@885kHz | |
| | | <-60 | -58 | dBc | ACPR@1980kHz | |
| Input VSWR | | 2:1 | | | | |
| Output VSWR | | | 10:1 | | No damage. | |
| | | | 6:1 | | No oscillations. >-70dBc | |



| | Specification | | | | O and Hilliam | |
|--|---------------|------|------|------|--|--|
| Parameter | Min. | Тур. | Max. | Unit | Condition | |
| High Power State CDMA 2000 1x (V _{MODE} LOW) | | | | | Case T=25°C, V _{CC} =3.4V, V _{REG} =2.85V. V _{MODE} =0V to 0.5V, Freq=824 MHz to 849 MHz (unless otherwise specified) | |
| Frequency Range | 824 | | 849 | MHz | | |
| Linear Gain | | 29 | | dB | | |
| Pilot+DCCH 9600 | | | | | | |
| Maximum Linear Output Power (CDMA 2000 Modulation) | 26.5 | | | dBm | 2.5 dB Backoff included in IS98D CCDF 1% 5.4 dB Peak Average Ratio at CCDF 1% | |
| Adjacent Channel Power Rejection | | -47 | | dBc | ACPR@885kHz | |
| | | <-60 | | dBc | ACPR@1.98MHz | |
| Pilot+FCH 9600+SCHO 9600 | | | | | | |
| Maximum Linear Output Power (CDMA 2000 Modulation) | 29 | | | dBm | 4.5dB Peak Average Ratio at CCDF 1% | |
| Adjacent Channel Power Rejection | | -47 | | dBc | ACPR@885kHz | |
| | | <-60 | | dBc | ACPR@1.98MHz | |
| Low Power State CDMA 2000 1x (V _{MODE} HIGH) | | | | | Case T=25°C, V _{CC} =3.4V, V _{REG} =2.85V. V _{MODE} =1.8V to 3V, Freq=824MHz to 849MHz | |
| Frequency Range | 824 | | 849 | MHz | | |
| Linear Gain | | 22 | | dB | | |
| Pilot+DCCH 9600 | | | | | | |
| Maximum Linear Output Power (CDMA 2000 Modulation) | 16 | 20 | | dBm | 5.4dB Peak to Average Ratio at CCDF 1% | |
| Adjacent Channel Power Rejection | | -48 | | dBc | ACPR@885kHz | |
| | | <-85 | | dBc | ACPR@1.98MHz | |
| Efficiency | | 15 | | % | P _{OUT} =20dBm | |
| Pilot+FCH 9600+SCHO 9600 | | | | | | |
| Maximum Linear Output Power (CDMA 2000 Modulation) | 16 | 20 | | dBm | 4.5dB Peak to Average Ratio at CCDF 1% | |
| Adjacent Channel Power Rejection | | <-50 | | dBc | ACPR@885kHz | |
| | | <-65 | | dBc | ACPR@1.98MHz | |
| FM Mode | | | | | Case T=25°C, V _{CC} =3.4V, V _{REG} =2.85V, V _{MODE} =0V to 0.5V, Freq=824 MHz to 849 MHz (unless otherwise specified) | |
| Frequency Range | 824 | | 849 | MHz | | |
| Gain | | 30 | | dB | | |
| Second Harmonic | | -33 | | dBc | | |
| Third Harmonic | | <-60 | | dBc | | |
| Max CW Output Power | 31 | 32 | | dBm | | |
| Total Efficiency (AMPS mode) | | 47 | | % | P _{OUT} =31dBm (room temperature) | |
| Input VSWR | | 2:1 | | | | |
| Output VSWR | | | 10:1 | | No damage. | |
| | | | 6:1 | | No oscillations. >-70dBc | |

Note: DCCH: Dedicated Control Channel FCH: Fundamental Channel

CCDF: Complementary Cumulative Distribution Function

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| Dovometer | Specification | | | Hait | Condition | |
|---|----------------|------|------|------|--|--|
| Parameter | Min. Typ. Max. | | Max. | Unit | Condition | |
| High Power State-CDMA450 (V _{MODE} Low) | | | | | Case T=25°C, V _{CC} =3.4V, V _{REG} =2.85V, V _{MODE} =0V to 0.5V, Freq=452 MHz to 458 MHz (unless otherwise specified) | |
| Frequency Range | 452 | | 458 | MHz | | |
| Linear Gain | | 31 | | dB | | |
| Second Harmonic | | 30 | | dBc | | |
| Third Harmonic | | -60 | | dBc | | |
| Maximum Linear Output Power (CDMA Modulation) | 29 | | | dBm | | |
| Total Linear Efficiency | | 35 | | % | P _{OUT} =29dBm | |
| Adjacent Channel Power Rejection | | -49 | | dBc | ACPR @ 885 kHz | |
| | | -56 | | dBc | ACPR @ 1980kHz | |
| Input VSWR | | 2:1 | | | | |
| Output VSWR | | | 10:1 | | No damage. | |
| | | | 6:1 | | No oscillations. > -70 dBc | |
| Low Power State-CDMA450 (V _{MODE} High) | | | | | Case T=25°C, V _{CC} =3.4V, V _{REG} =2.85V, V _{MODE} =2.85V, Freq=452MHz to 458MHz (unless otherwise specified) | |
| Frequency Range | 452 | | 458 | MHz | | |
| Linear Gain | | 23 | | dB | | |
| Maximum Linear Output Power (CDMA Modulation) | 16 | | | dBm | | |
| Max I _{CC} | | 160 | | mA | P _{OUT} =+16dBm (all currents included) | |
| Adjacent Channel Power Rejection | | -52 | | dBc | ACPR @ 885kHz | |
| | | -70 | | dBc | ACPR @ 1980kHz | |
| Input VSWR | | 2:1 | | | | |
| Output VSWR | | | 10:1 | | No damage. | |
| | | | 6:1 | | No oscillations. > -70dBc | |
| DC Supply | | | | | | |
| Supply Voltage | 3.0 | 3.4 | 4.2 | V | The maximum power out for V _{CC} =3.0V is 28dBm. | |
| Quiescent Current | | 160 | | mA | V _{MODE} =Low | |
| | | 45 | 70 | mA | V _{MODE} =High | |
| V _{REG} Current | | | 10 | mA | | |
| V _{MODE} Current | | | 1 | mA | | |
| Turn On/Off Time | | | <40 | μs | Time between V_{REG} turned on and PA reaching full power. Turn on/off time can be reduced by lowering the bypass capacitor value on the V_{REG} line. | |
| Total Current (Power Down) | | | 10 | μΑ | V _{REG} =Low | |
| V _{REG} "Low" Voltage | 0 | | 0.5 | V | | |
| V _{REG} "High" Voltage | 2.75 | 2.85 | 2.95 | V | | |
| V _{MODE} "Low" Voltage | 0 | | 0.5 | V | | |
| V _{MODE} "High" Voltage | 1.8 | 2.85 | 3.0 | V | | |

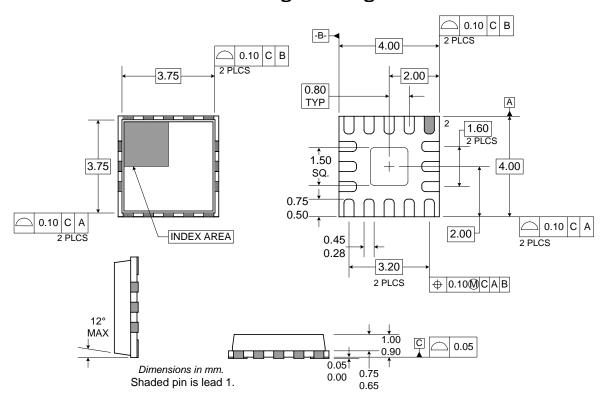


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| Pin | Function | Description | Interface Schematic |
|-------------|-----------------|--|---|
| 1 | GND | Ground connection. | |
| 2 | GND | Ground connection. | |
| 3 | GND | Ground connection. | |
| 4 | RF IN | RF input. An external 100 pF series capacitor is required as a DC block. In addition, shunt inductor and series capacitor are required to provide 2:1VSWR. | VCC1 100 pF RF INO Bias GND1 Stages |
| 5 | VREG1 | Power Down control for first stage. Regulated voltage supply for amplifier bias. In Power Down mode, both V_{REG} and V_{MODE} need to be LOW (<0.5 V). | |
| 6 | VMODE | For nominal operation (High Power Mode), V _{MODE} is set LOW. When set HIGH, the driver and final stage are dynamically scaled to reduce the device size and as a result to reduce the idle current. | |
| 7 | VREG2 | Power Down control for the second stage. Regulated voltage supply for amplifier bias. In Power Down mode, both V_{REG} and V_{MODE} need to be LOW (<0.5 V). | |
| 8 | BIAS GND | Bias circuitry ground. See application schematic. | |
| 9 | GND | Ground connection. | |
| 10 | RF OUT | RF output and power supply for final stage. This is the unmatched collector output of the second stage. A DC block is required following the matching components. The biasing may be provided via a parallel L-C set for resonance at the operating frequency of 824MHz to 849MHz. It is important to select an inductor with very low DC resistance with a 1A current rating. Alternatively, shunt microstrip techniques are also applicable and provide very low DC resistance. Low frequency bypassing is required for stability. | RFOUT From Bias Stages |
| 11 | RF OUT | Same as pin 10. | See pin 10. |
| 12 | RF OUT | Same as pin 10. | |
| 13 | 2F0 | Harmonic trap. This pin connects to the RF output but is used for providing a low impedance to the second harmonic of the operating frequency. An inductor or transmission line resonating with an on chip capacitor at 2fo is required at this pin. | |
| 14 | VCC BIAS | Power supply for bias circuitry. A 100 pF high frequency bypass capacitor is recommended. | |
| 15 | VCC1 | Power supply for first stage. | |
| 16 | VCC1 | Same as Pin 15. | |
| Pkg Base | GND | Ground connection. The backside of the package should be soldered to a top side ground pad which is connected to the ground plane with multiple vias. The pad should have a short thermal path to the ground plane. | |



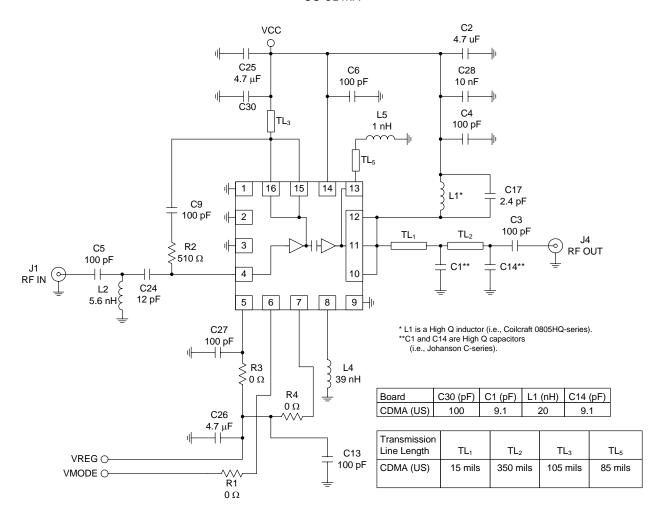
Package Drawing





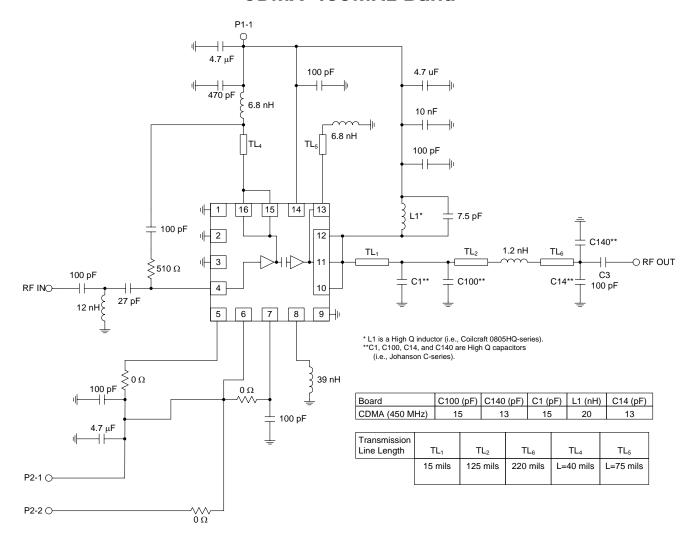
Evaluation Board Schematic

US-CDMA





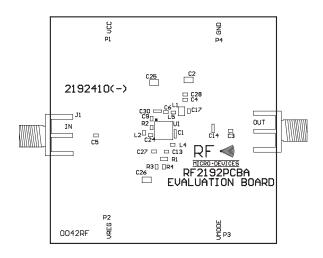
Application Schematic CDMA-450MHz Band

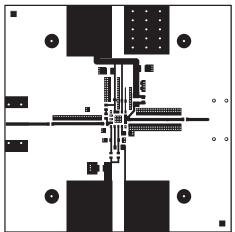


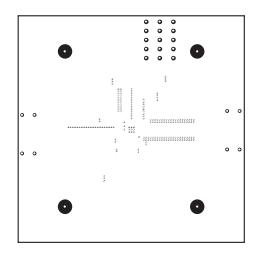


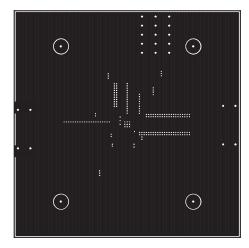
Evaluation Board Layout - US-CDMA 2.0" x 2.0"

Board Thickness 0.031", Board Material FR-4, Multi-Layer, Ground Plane at 0.015"











PCB Design Requirements

PCB Surface Finish

The PCB surface finish used for RFMD's qualification process is electroless nickel, immersion gold. Typical thickness is 3μ inch to 8μ inch gold over 180μ inch nickel.

PCB Land Pattern Recommendation

PCB land patterns are based on IPC-SM-782 standards when possible. The pad pattern shown has been developed and tested for optimized assembly at RFMD; however, it may require some modifications to address company specific assembly processes. The PCB land pattern has been developed to accommodate lead and package tolerances.

PCB Metal Land Pattern

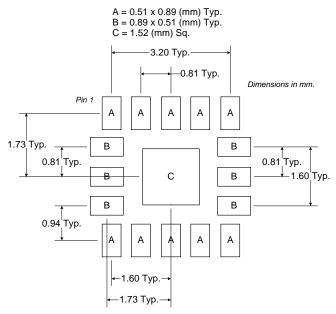


Figure 1. PCB Metal Land Pattern (Top View)



PCB Solder Mask Pattern

Liquid Photo-Imageable (LPI) solder mask is recommended. The solder mask footprint will match what is shown for the PCB Metal Land Pattern with a 3mil expansion to accommodate solder mask registration clearance around all pads. The center-grounding pad shall also have a solder mask clearance. Expansion of the pads to create solder mask clearance can be provided in the master data or requested from the PCB fabrication supplier.

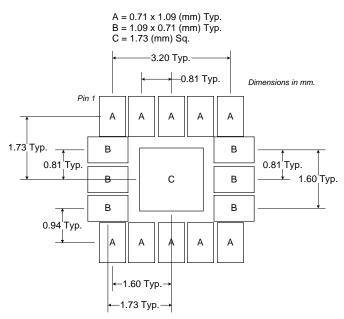


Figure 2. PCB Solder Mask (Top View)

Thermal Pad and Via Design

The PCB metal land pattern has been designed with a thermal pad that matches the exposed die paddle size on the bottom of the device.

Thermal vias are required in the PCB layout to effectively conduct heat away from the package. The via pattern has been designed to address thermal, power dissipation and electrical requirements of the device as well as accommodating routing strategies.

The via pattern used for the RFMD qualification is based on thru-hole vias with 0.203mm to 0.330mm finished hole size on a 0.5mm to 1.2mm grid pattern with 0.025mm plating on via walls. If micro vias are used in a design, it is suggested that the quantity of vias be increased by a 4:1 ratio to achieve similar results.

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